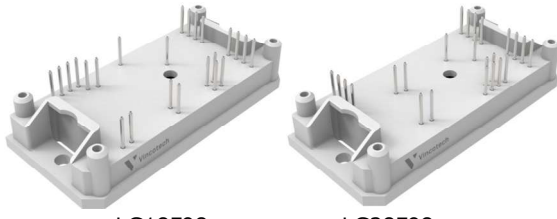
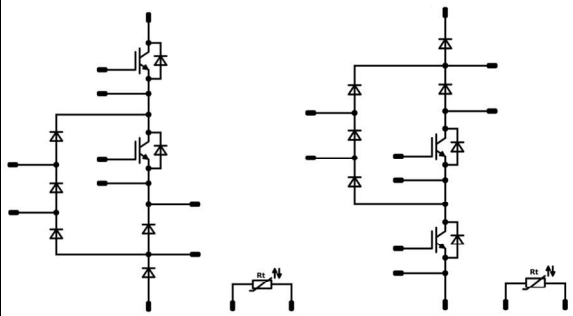




Vincotech

# 10-F124NID150SH03-LG18F98 10-F124NIE150SH03-LG28F98

datasheet

flow NPC 1 split		1500 V / 150 A	
<b>Features</b> <ul style="list-style-type: none"> <li>Enhanced efficiency</li> <li>Low inductive package</li> <li>Tandem diodes</li> </ul>		<b>flow 1 housing</b>  LG18F98      LG28F98	
<b>Target applications</b> <ul style="list-style-type: none"> <li>Solar Inverters</li> </ul>		<b>Schematic</b>  LG18F98      LG28F98	
<b>Types</b> <ul style="list-style-type: none"> <li>10-F124NID150SH03-LG18F98</li> <li>10-F124NIE150SH03-LG28F98</li> </ul>			

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Buck Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	109	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	450	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	243	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$T_j \leq 150\text{ °C}$	10	$\mu s$
	$V_{CC}$	$V_{GE} = 15\text{ V}$	800	V
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}C$



Vincotech

**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Buck Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1300	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	115	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	300	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	300	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Buck Sw. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Surge (non-repetitive) forward current	$I_{FSM}$	50 Hz Single Half Sine Wave $t_p = 8,3\text{ ms}$ $T_j = 150\text{ °C}$	270	A
Surge current capability	$I^2t$		365	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	94	W
Maximum junction temperature	$T_{jmax}$		175	°C

### Boost Switch

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	139	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	300	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	254	W
Gate-emitter voltage	$V_{GES}$		±20	V
Maximum junction temperature	$T_{jmax}$		175	°C

### Boost Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Surge (non-repetitive) forward current	$I_{FSM}$	50 Hz Single Half Sine Wave $t_p = 8,3\text{ ms}$ $T_j = 150\text{ °C}$	270	A
Surge current capability	$I^2t$		365	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	94	W
Maximum junction temperature	$T_{jmax}$		175	°C



## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Boost Sw. Inv. Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		1600	V
Continuous (direct) forward current	$I_F$		50	A
Surge (non-repetitive) forward current	$I_{FSM}$	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	490	A
Surge current capability	$I^2t$		1200	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	78	W
Maximum Junction Temperature	$T_{jmax}$		150	°C

<b>Boost Sw. Protection Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		1600	V
Continuous (direct) forward current	$I_F$		50	A
Surge (non-repetitive) forward current	$I_{FSM}$	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	490	A
Surge current capability	$I^2t$		1200	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	78	W
Maximum Junction Temperature	$T_{jmax}$		150	°C

<b>Boost D. Protection Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	32	A
Surge (non-repetitive) forward current	$I_{FSM}$	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	170	A
Surge current capability	$I^2t$		145	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	71	W
Maximum Junction Temperature	$T_{jmax}$		175	°C



Vincotech

**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

## Maximum Ratings

$T_j = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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## Module Properties

### Thermal Properties

Storage temperature	$T_{\text{stg}}$		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	$T_{\text{top}}$		-40...( $T_{\text{jmax}}$ - 25)	$^{\circ}\text{C}$

### Isolation Properties

Isolation voltage	$V_{\text{isol}}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	

\*100% Tested in production



Vincotech

**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Buck Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0052	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		150	25 125 150	1,78	2,16 2,48 2,56	2,42	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			2	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			240	nA
Internal gate resistance	$r_g$							none		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ MHz}$	0	25		25		8800		pF
Reverse transfer capacitance	$C_{res}$							470		
Gate charge	$Q_g$		15			25		1140		nC

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK (PSX)}$						0,39		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	$\pm 15$	600	150	25 125 150		116 120 120		ns
Rise time	$t_r$					25 125 150		20 23 24		
Turn-off delay time	$t_{d(off)}$					25 125 150		213 267 279		
Fall time	$t_f$					25 125 150		20 66 75		
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 4,4 \mu\text{C}$ $Q_{tFWD} = 8,4 \mu\text{C}$ $Q_{tFWD} = 9,7 \mu\text{C}$				25 125 150		6,23 8,57 9,33		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		5,36 9,58 10,74		



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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Buck Diode

#### Static

Forward voltage	$V_F$				150	25 125 150		3,12 3,00 2,96	3,84	V
Reverse leakage current	$I_r$			1300		25			7,6	μA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,32		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt = 8628 \text{ A/}\mu\text{s}$ $di/dt = 8113 \text{ A/}\mu\text{s}$ $di/dt = 8006 \text{ A/}\mu\text{s}$	$\pm 15$	600	150	25 125 150		110 139 151		A
Reverse recovery time	$t_{rr}$					25 125 150		79 111 124		ns
Recovered charge	$Q_r$					25 125 150		4,42 8,38 9,74		μC
Reverse recovered energy	$E_{rec}$					25 125 150		1,50 3,08 3,62		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		7069 1003 1214		A/μs

### Buck Sw. Protection Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		2,21 2,31 2,22	2,54	V
Reverse leakage current	$I_R$			1200		25 150			60 8800	μA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,02		K/W
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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,015	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		150	25 125 150		1,63 1,80 1,85	1,9	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			220	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			1000	nA
Internal gate resistance	$r_g$							2		Ω
Input capacitance	$C_{ies}$	0	10		25			32000		pF
Output capacitance	$C_{oes}$							960		
Reverse transfer capacitance	$C_{res}$							380		
Gate charge	$Q_g$		15	600	150	25		980		nC

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,37		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$	±15	600	156	25 125 150		617 616 613		ns
Rise time	$t_r$					25 125 150		89 106 109		
Turn-off delay time	$t_{d(off)}$					25 125 150		407 440 451		
Fall time	$t_f$					25 125 150		78 101 107		
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 5 \mu\text{C}$ $Q_{tFWD} = 8,8 \mu\text{C}$ $Q_{tFWD} = 10,5 \mu\text{C}$				25 125 150		17,98 22,93 22,80		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		11,54 15,65 15,94		



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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		2,21 2,31 2,22	2,54	V
Reverse leakage current	$I_R$			1200		25 150			60 8800	µA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK (PSX)}$						1,02		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt = 1701 \text{ A/}\mu\text{s}$ $di/dt = 1425 \text{ A/}\mu\text{s}$ $di/dt = 1456 \text{ A/}\mu\text{s}$	$\pm 15$	600	156	25 125 150		43 48 50		A
Reverse recovery time	$t_{rr}$					25 125 150		388 590 672		ns
Recovered charge	$Q_r$					25 125 150		4,99 8,80 10,49		µC
Reverse recovered energy	$E_{rec}$					25 125 150		1,69 3,15 3,81		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		1139 326 238		A/µs

### Boost Sw. Inv. Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,14 1,08 1,07	1,21	V
Reverse leakage current	$I_r$			1600		25 145			50 1100	µA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK (PSX)}$						0,90		K/W
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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Sw. Protection Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,14 1,08 1,07	1,21	V
Reverse leakage current	$I_r$			1600		25 145			50 1100	μA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,90		K/W
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### Boost D. Protection Diode

#### Static

Forward voltage	$V_F$				35	25 125 150		2,38 2,41 2,37	2,62	V
Reverse leakage current	$I_r$			1200		25 150			60 5500	μA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,34		K/W
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### Thermistor

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$					25		5		mW
Power dissipation constant						25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$				25		3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$				25		4000		K
Vincotech NTC Reference									I	



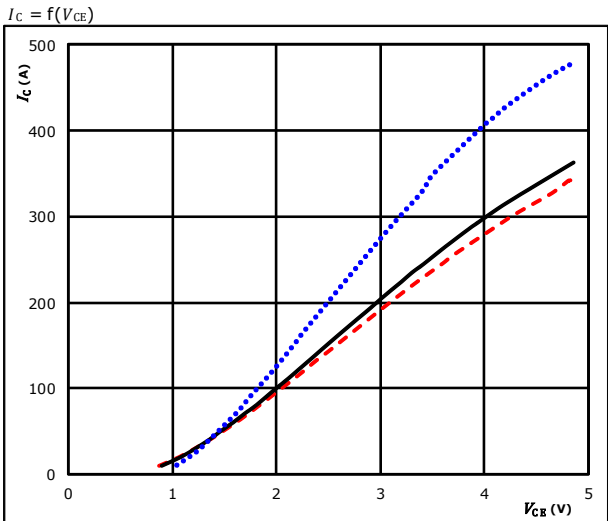
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# 10-F124NID150SH03-LG18F98 10-F124NIE150SH03-LG28F98 datasheet

## Buck Switch Characteristics

**figure 1.** IGBT

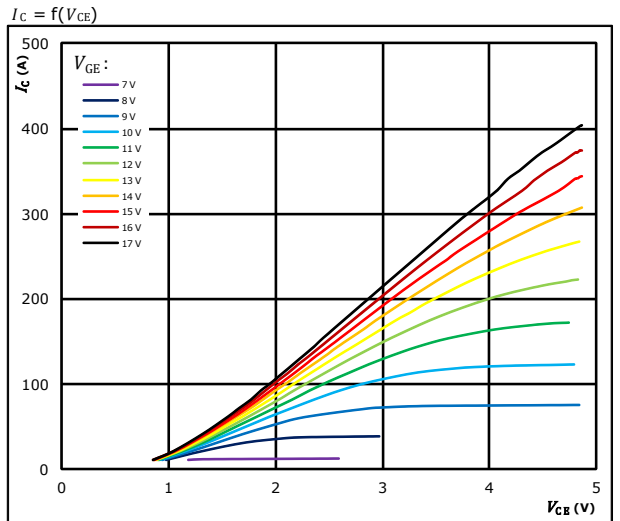
Typical output characteristics



$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ } ^\circ C$  (blue dotted line)  
 $125 \text{ } ^\circ C$  (black solid line)  
 $150 \text{ } ^\circ C$  (red dashed line)

**figure 2.** IGBT

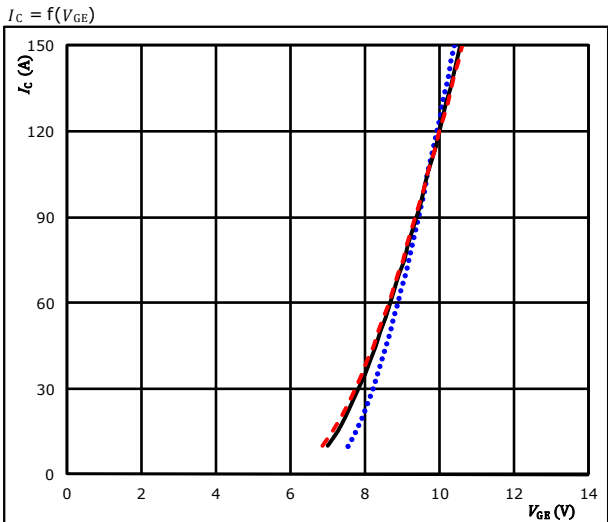
Typical output characteristics



$t_p = 250 \mu s$   
 $T_j = 125 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

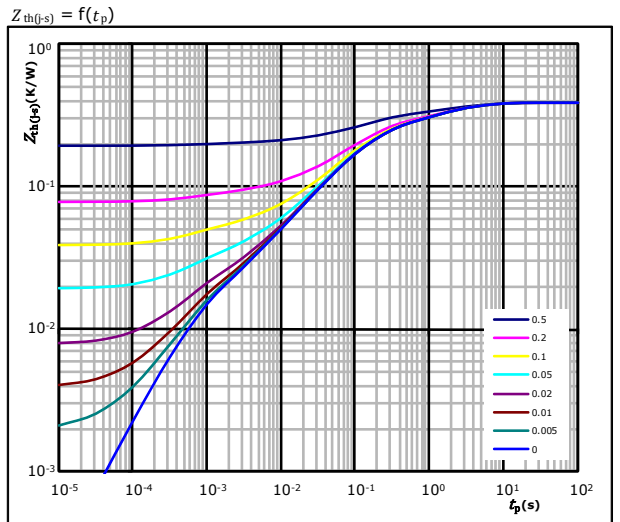
Typical transfer characteristics



$t_p = 100 \mu s$   
 $V_{CE} = 10 V$   
 $T_j: 25 \text{ } ^\circ C$  (blue dotted line)  
 $125 \text{ } ^\circ C$  (black solid line)  
 $150 \text{ } ^\circ C$  (red dashed line)

**figure 4.** IGBT

Transient thermal impedance as function of pulse duration



$D = t_p / T$   
 $R_{th(j-s)} = 0,39 \text{ K/W}$   
IGBT thermal model values  

$R \text{ (K/W)}$	$\tau \text{ (s)}$
6,04E-02	3,83E+00
8,82E-02	1,06E+00
1,40E-01	1,49E-01
6,72E-02	4,78E-02
2,05E-02	8,33E-03
1,38E-02	7,18E-04



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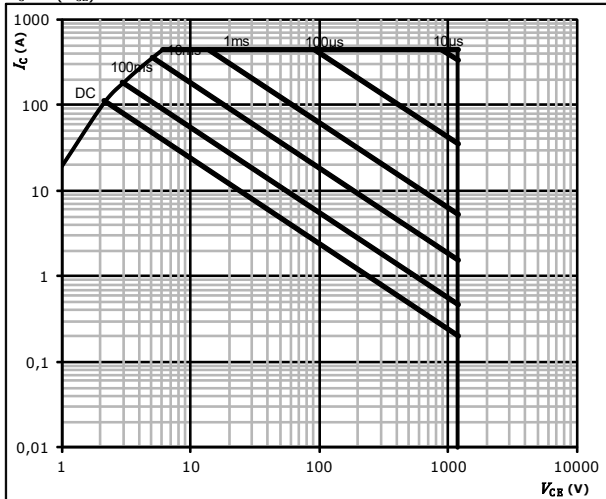
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

## Buck Switch Characteristics

**figure 5.** IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$  single pulse  
 $T_s =$  80 °C  
 $V_{GE} =$   $\pm 15$  V  
 $T_j =$   $T_{jmax}$

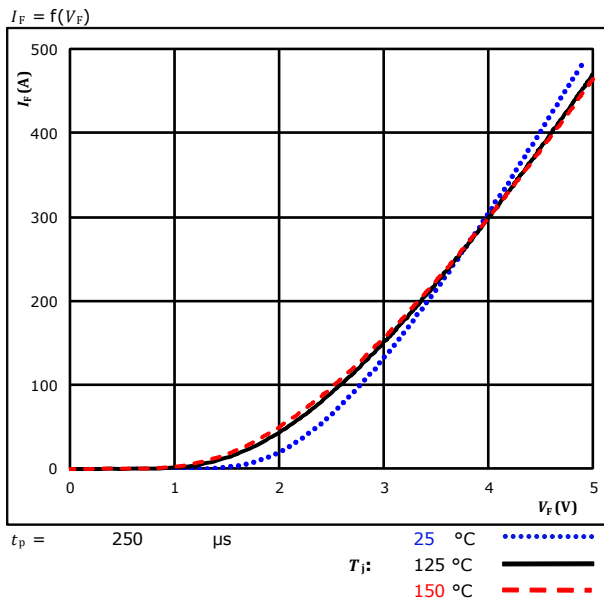


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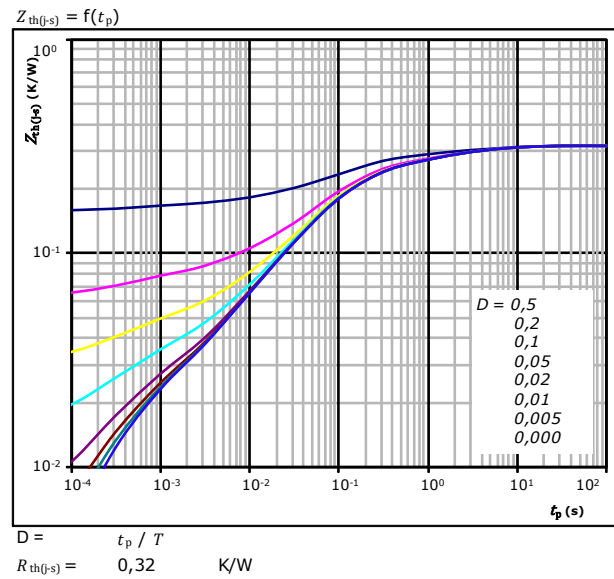
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Buck Diode Characteristics

**figure 1.** FWD  
**Typical forward characteristics**



**figure 2.** FWD  
**Transient thermal impedance as a function of pulse width**



FWD thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
2,36E-02	6,39E+00
4,54E-02	1,45E+00
6,78E-02	2,29E-01
1,22E-01	6,68E-02
3,48E-02	9,88E-03
7,34E-03	1,81E-03
1,51E-02	3,29E-04



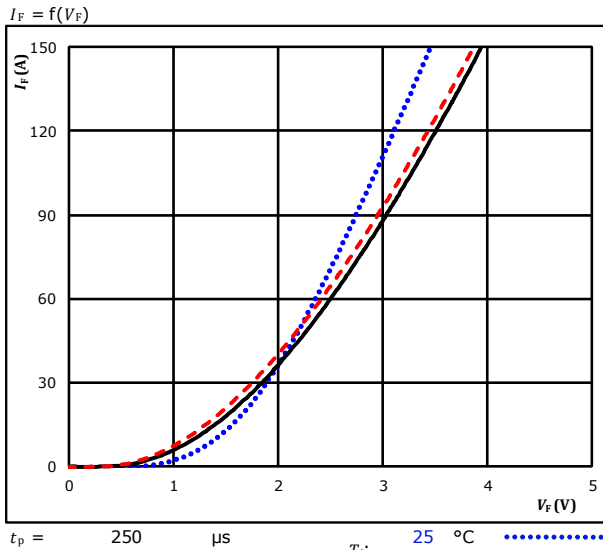
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 datasheet

## Buck Sw. Protection Diode Characteristics

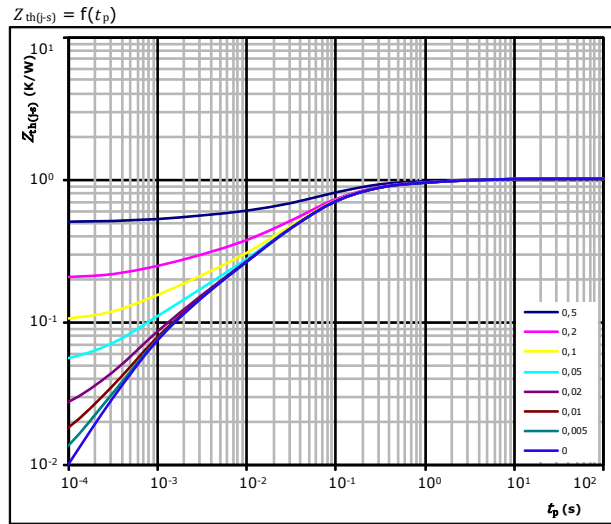
**figure 1.** Prot. Diode

Typical forward characteristics



**figure 2.** Prot. Diode

Transient thermal impedance as a function of pulse width





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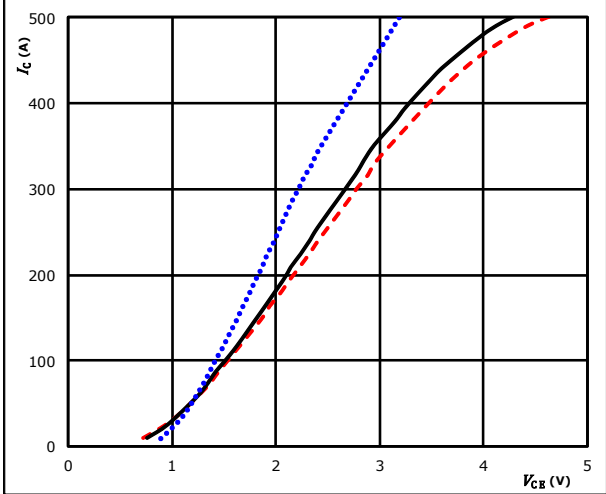
# 10-F124NID150SH03-LG18F98 10-F124NIE150SH03-LG28F98 datasheet

## Boost Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

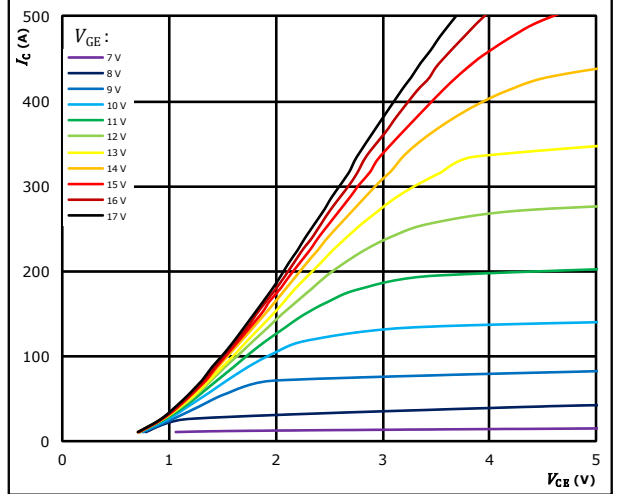


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ } ^\circ C$  (blue dotted line)  
 $125 \text{ } ^\circ C$  (black solid line)  
 $150 \text{ } ^\circ C$  (red dashed line)

**figure 2.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

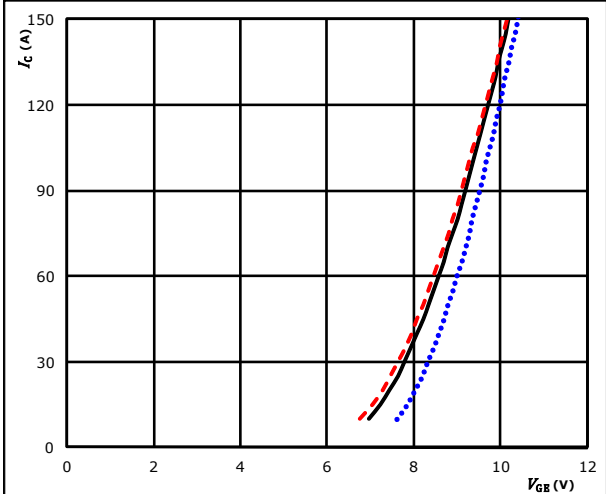


$t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

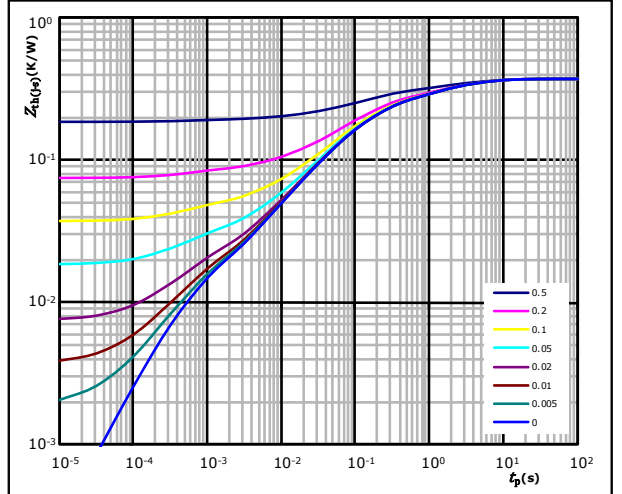


$t_p = 100 \mu s$   
 $V_{CE} = 10 V$   
 $T_j: 25 \text{ } ^\circ C$  (blue dotted line)  
 $125 \text{ } ^\circ C$  (black solid line)  
 $150 \text{ } ^\circ C$  (red dashed line)

**figure 4.** IGBT

Transient thermal impedance as function of pulse duration

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,37 \text{ K/W}$

IGBT thermal model values

$R$ (K/W)	$\tau$ (s)
6,05E-02	4,47E+00
8,70E-02	9,84E-01
1,28E-01	1,45E-01
6,38E-02	4,36E-02
2,32E-02	8,52E-03
1,16E-02	5,08E-04



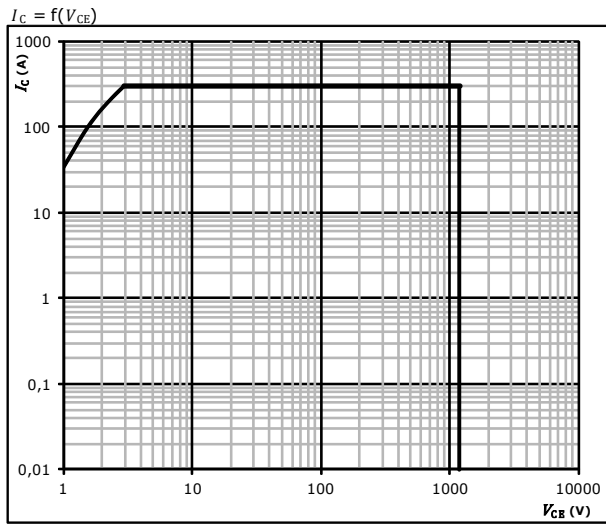
Vincotech

**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

## Boost Switch Characteristics

**figure 5.** IGBT

Safe operating area



$D =$  single pulse  
 $T_s =$  80 °C  
 $V_{GE} =$  ±15 V  
 $T_j =$   $T_{jmax}$



Vincotech

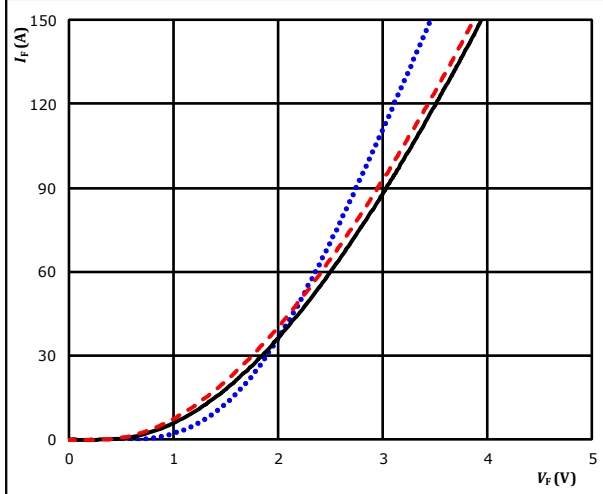
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Boost Diode Characteristics

**figure 1.** FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

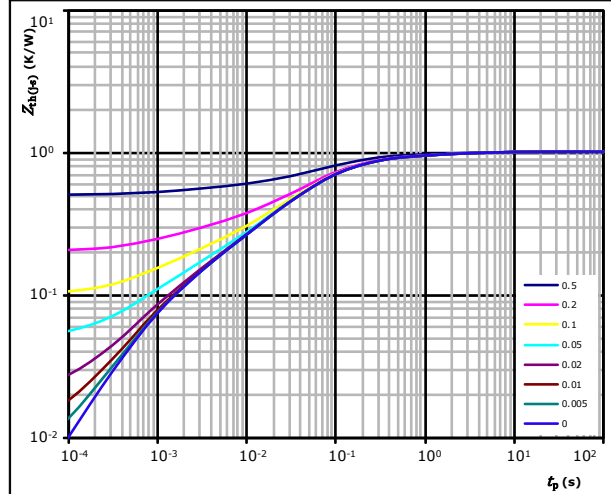
$T_j$ :

- 25 °C (blue dotted line)
- 125 °C (black solid line)
- 150 °C (red dashed line)

**figure 2.** FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 1,02 \text{ K/W}$

FWD thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
5,56E-02	3,42E+00
1,14E-01	5,52E-01
4,09E-01	9,78E-02
2,64E-01	3,21E-02
9,94E-02	6,42E-03
7,49E-02	9,84E-04

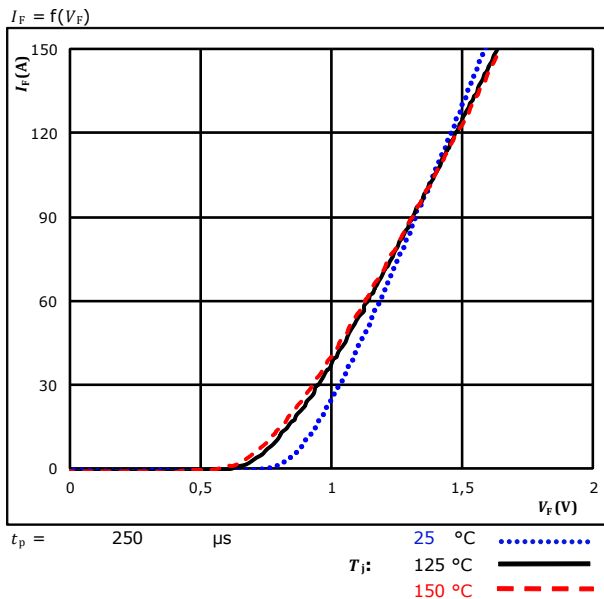


Vincotech

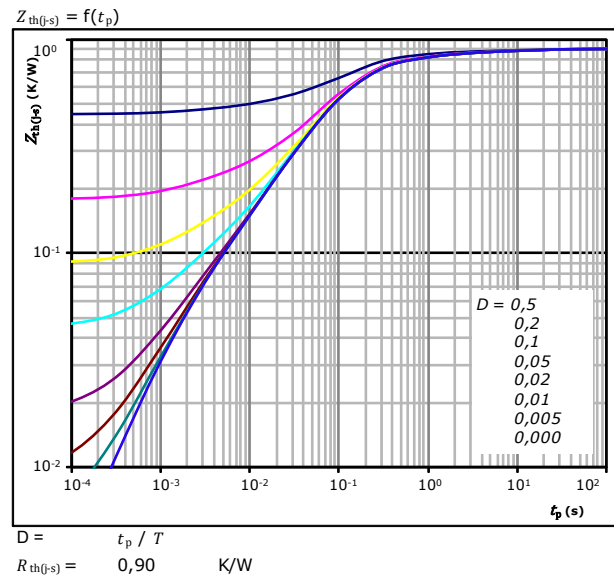
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Boost Sw. Inv. Diode Characteristics

**figure 1.** Inverse Diode  
 Typical forward characteristics



**figure 2.** Inverse Diode  
 Transient thermal impedance as a function of pulse width



Inverse Diode thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
2,22E-01	2,31E-01
4,39E-01	7,58E-02
8,14E-02	1,11E-02
3,58E-02	1,56E-03

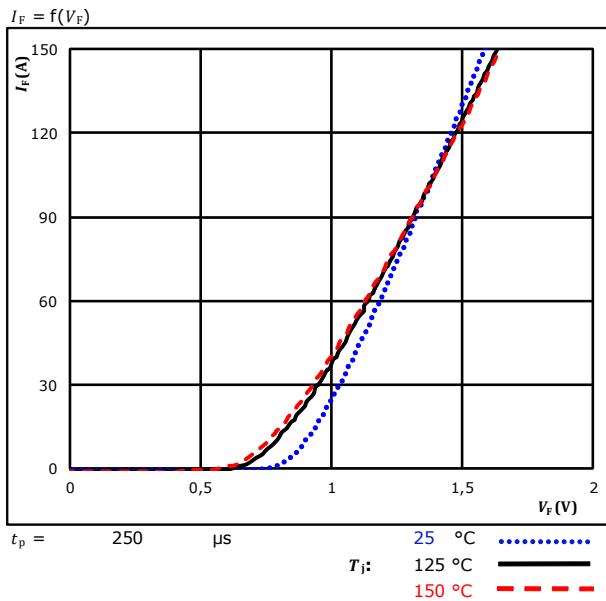


Vincotech

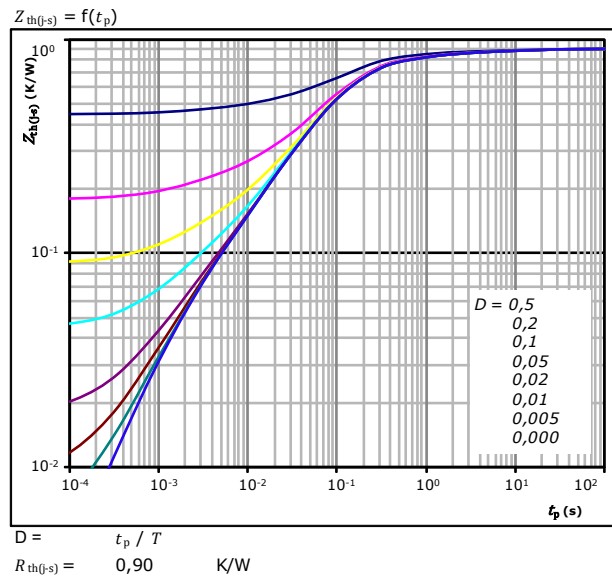
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Boost Sw. Protection Diode Characteristics

**figure 1.** Prot. Diode  
**Typical forward characteristics**



**figure 2.** Prot. Diode  
**Transient thermal impedance as a function of pulse width**



Prot. Diode thermal model values

$R$ (K/W)	$\tau$ (s)
2,22E-01	2,31E-01
4,39E-01	7,58E-02
8,14E-02	1,11E-02
3,58E-02	1,56E-03

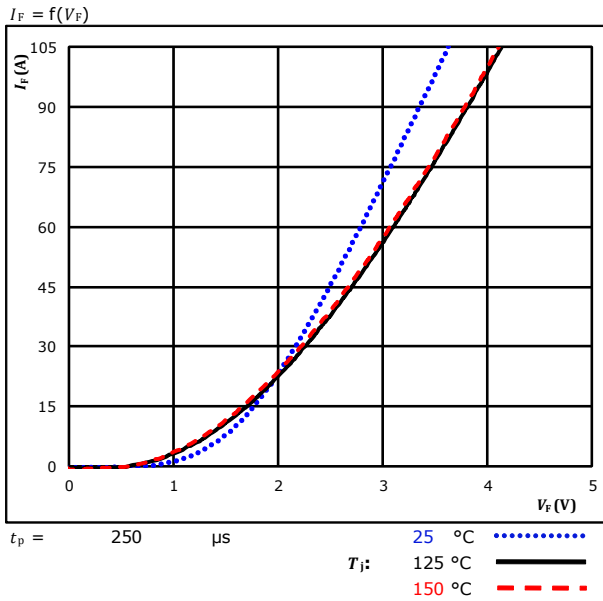


Vincotech

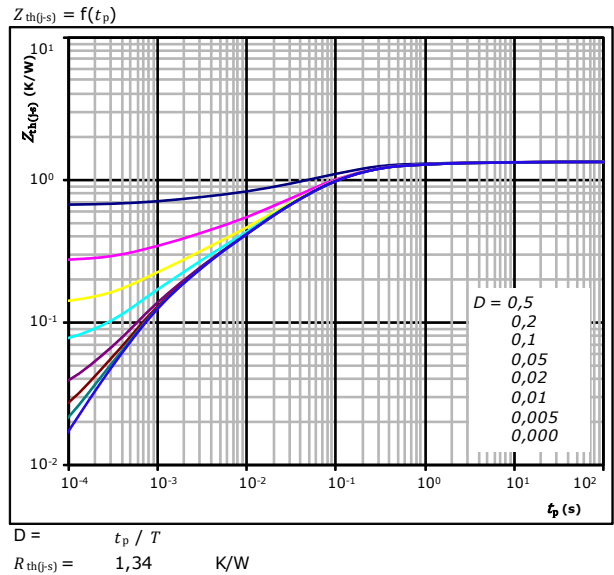
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Boost D. Protection Diode Characteristics

**figure 1.** Prot. Diode  
**Typical forward characteristics**



**figure 2.** Prot. Diode  
**Transient thermal impedance as a function of pulse width**

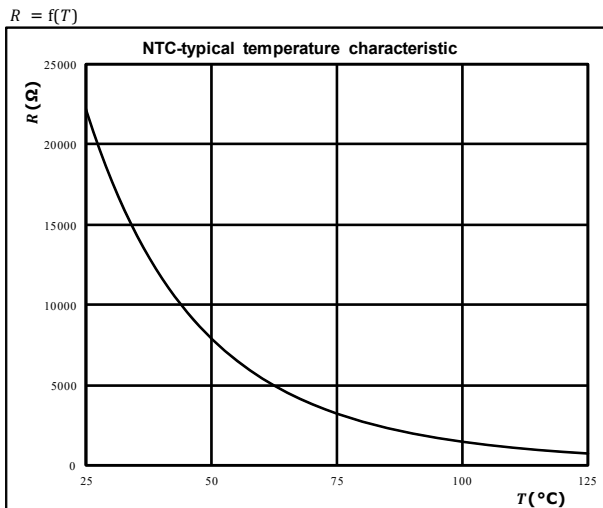


Prot. Diode thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
3,06E-02	9,16E+00
1,47E-01	6,10E-01
6,10E-01	8,89E-02
2,96E-01	2,14E-02
1,39E-01	5,05E-03
1,19E-01	9,19E-04

## Thermistor Characteristics

**figure 1.** Thermistor  
**Typical NTC characteristic as a function of temperature**





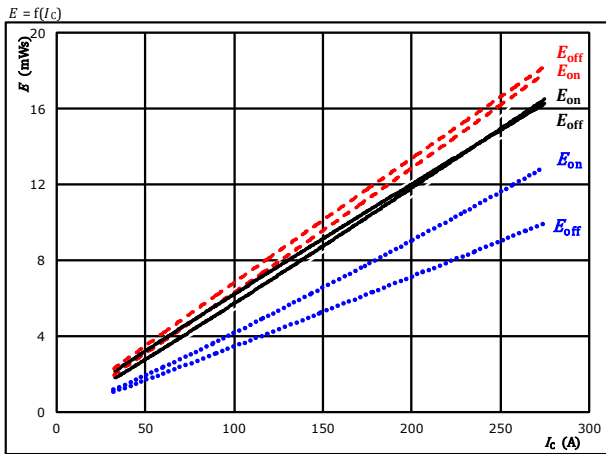
Vincotech

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**10-F124NIE150SH03-LG28F98**  
 datasheet

## Buck Switching Characteristics

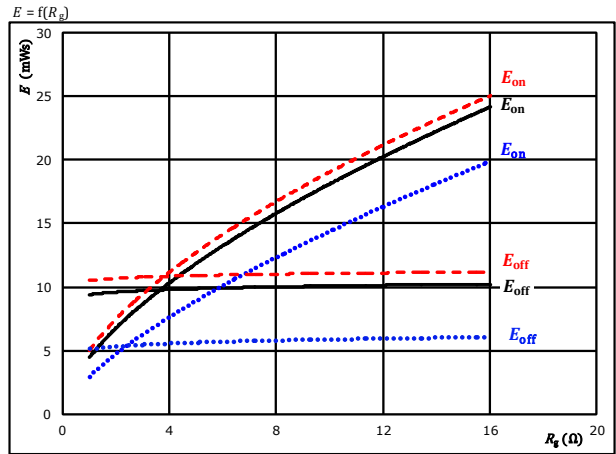
**figure 1.** IGBT

Typical switching energy losses as a function of collector current



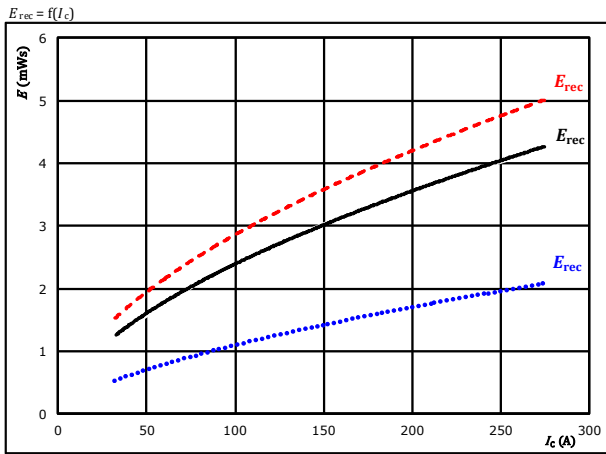
**figure 2.** IGBT

Typical switching energy losses as a function of gate resistor



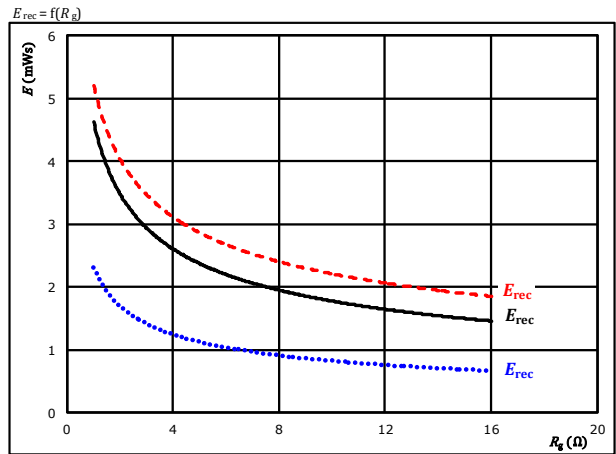
**figure 3.** FWD

Typical reverse recovered energy loss as a function of collector current



**figure 4.** FWD

Typical reverse recovered energy loss as a function of gate resistor





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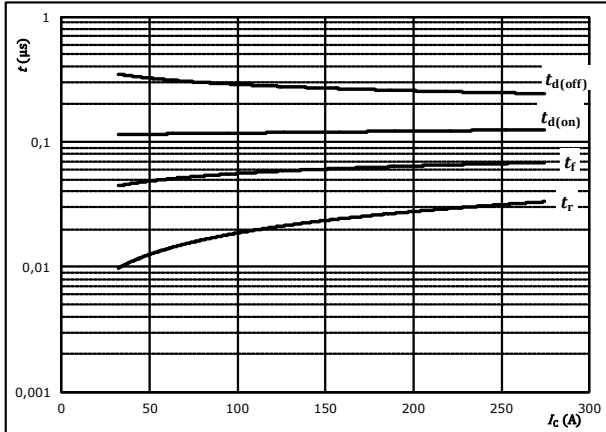
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Buck Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



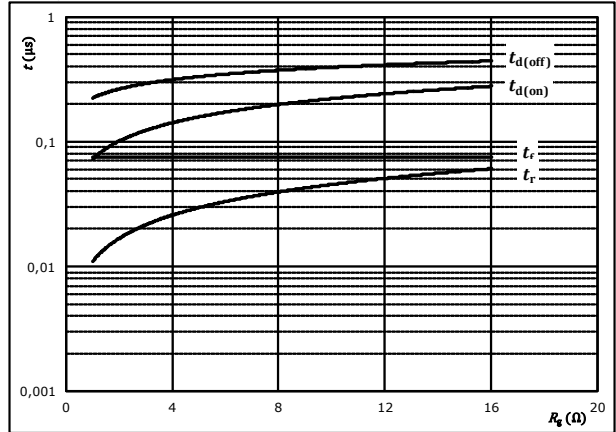
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 4$  Ω  
 $R_{goff} = 4$  Ω

**figure 6.** IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



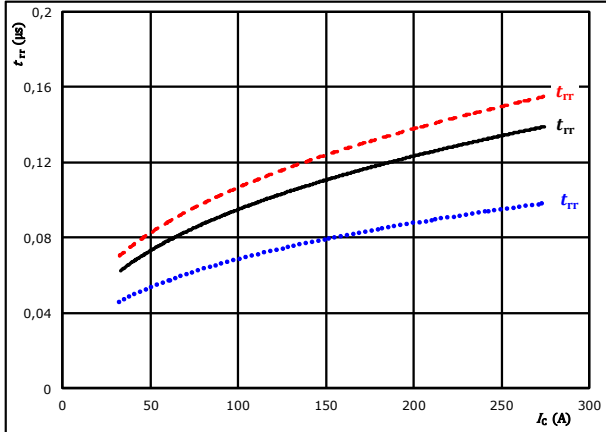
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 150$  A

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

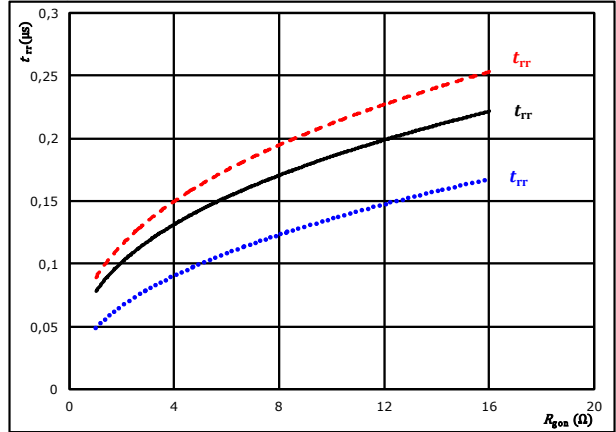


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 4$  Ω  
 $T_j: 25$  °C .....  
 $125$  °C .....  
 $150$  °C - - - - -

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 150$  A  
 $T_j: 25$  °C .....  
 $125$  °C .....  
 $150$  °C - - - - -



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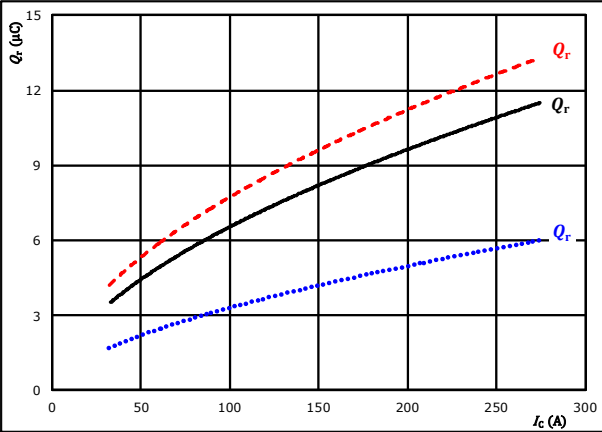
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Buck Switching Characteristics

**figure 9.** FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_C)$$

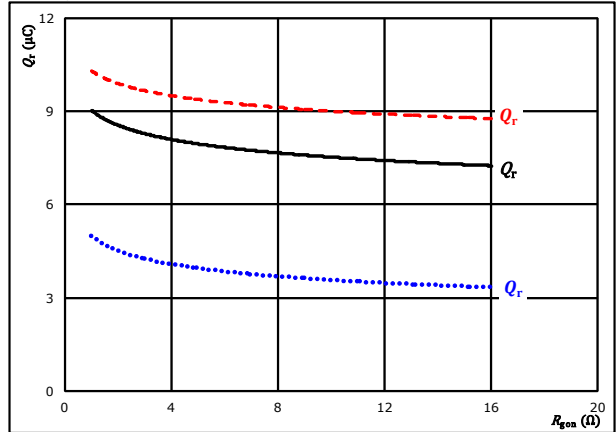


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

**figure 10.** FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$

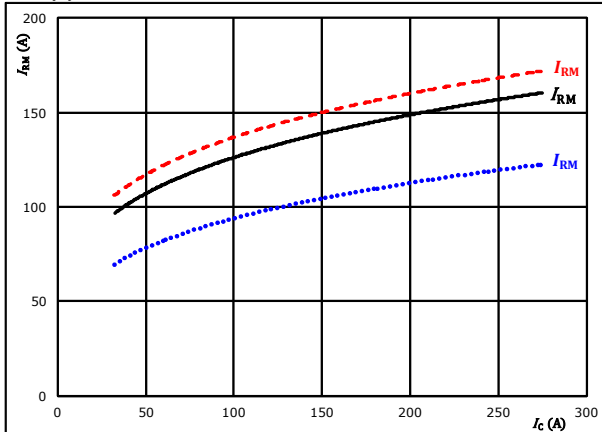


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 150$  A  
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

**figure 11.** FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_C)$$

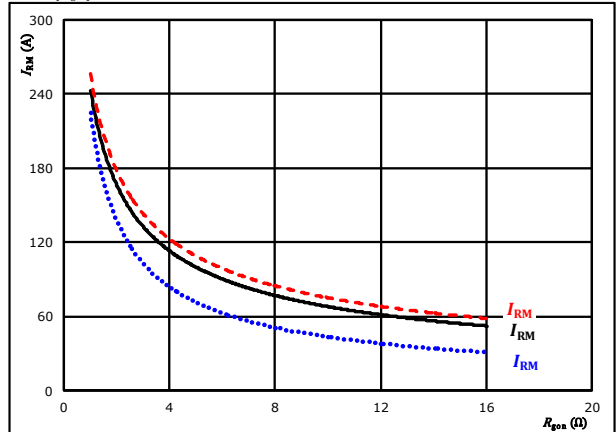


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

**figure 12.** FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 150$  A  
 $T_j$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)



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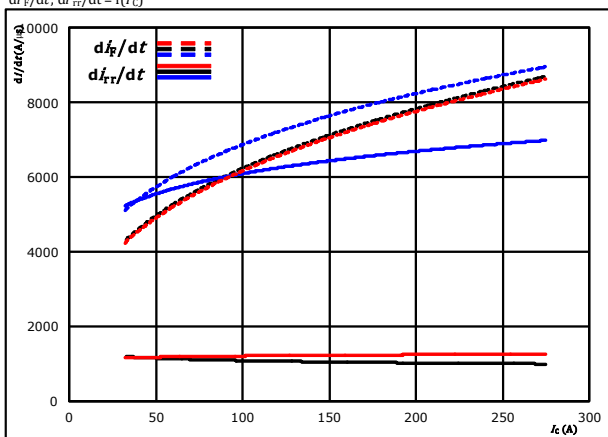
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Buck Switching Characteristics

**figure 13.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$di_F/dt, di_{rr}/dt = f(I_C)$$

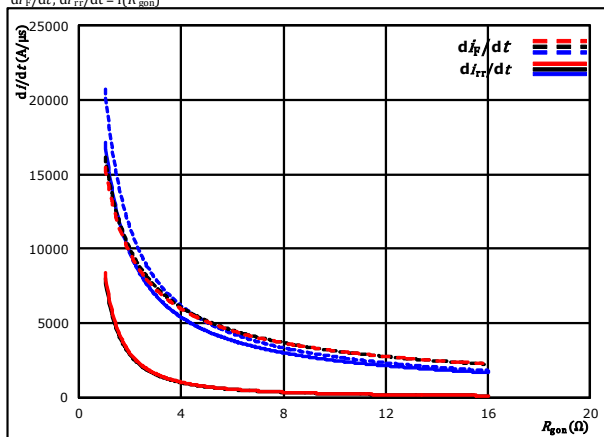


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g0n} = 4$  Ω  
 $T_J = 25^\circ\text{C}$  (dotted blue)  
 $125^\circ\text{C}$  (solid black)  
 $150^\circ\text{C}$  (dashed red)

**figure 14.** FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$di_F/dt, di_{rr}/dt = f(R_{g0n})$$

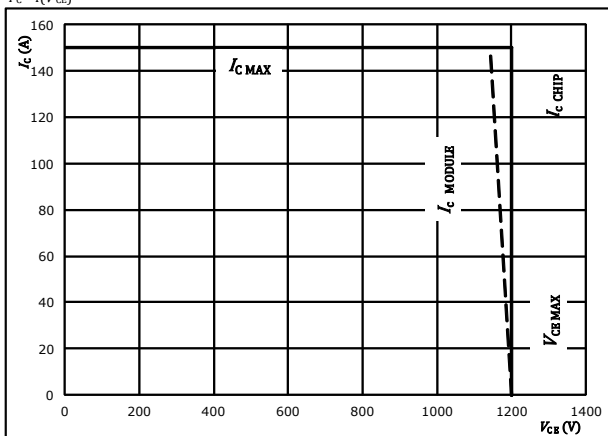


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 150$  A  
 $T_J = 25^\circ\text{C}$  (dotted blue)  
 $125^\circ\text{C}$  (solid black)  
 $150^\circ\text{C}$  (dashed red)

**figure 15.** IGBT

Reverse bias safe operating area

$$I_C = f(V_{CE})$$



At  $T_J = 175^\circ\text{C}$   
 $R_{g0n} = 4$  Ω  
 $R_{g0ff} = 4$  Ω



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datasheet

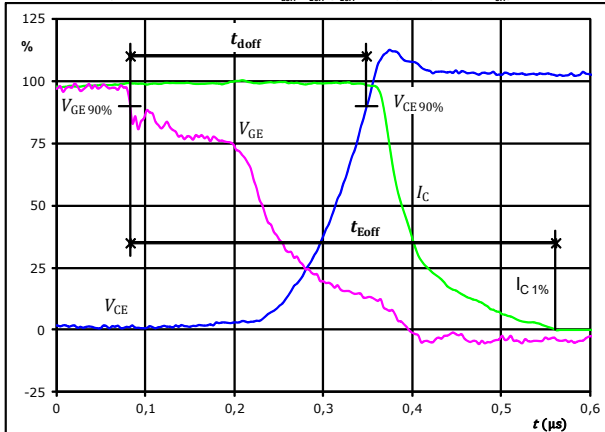
## Buck Switching Characteristics

### General conditions

$T_j$	=	125 °C
$R_{gon}$	=	4 $\Omega$
$R_{goff}$	=	4 $\Omega$

figure 1. IGBT

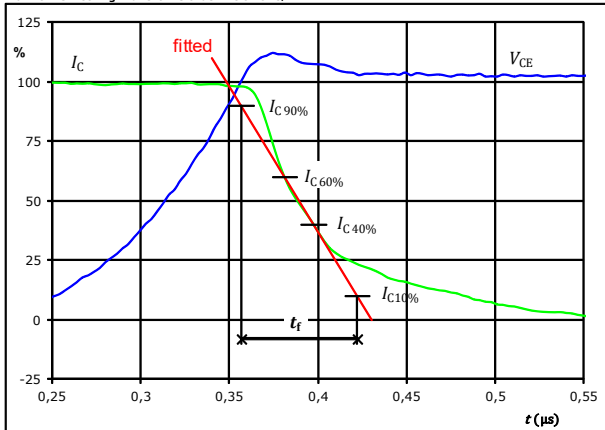
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	150	A
$t_{doff} =$	0,267	$\mu s$
$t_{Eoff} =$	0,479	$\mu s$

figure 3. IGBT

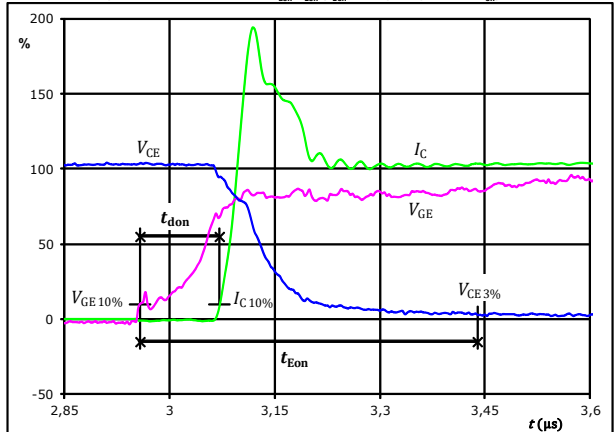
Turn-off Switching Waveforms & definition of  $t_r$



$V_C(100\%) =$	600	V
$I_C(100\%) =$	150	A
$t_r =$	0,066	$\mu s$

figure 2. IGBT

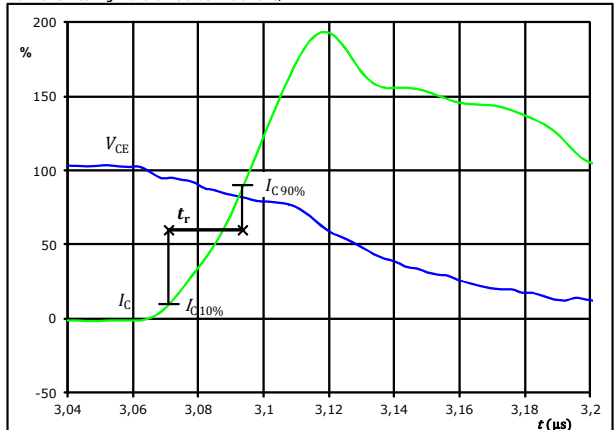
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	150	A
$t_{don} =$	0,120	$\mu s$
$t_{Eon} =$	0,481	$\mu s$

figure 4. IGBT

Turn-on Switching Waveforms & definition of  $t_r$



$V_C(100\%) =$	600	V
$I_C(100\%) =$	150	A
$t_r =$	0,023	$\mu s$

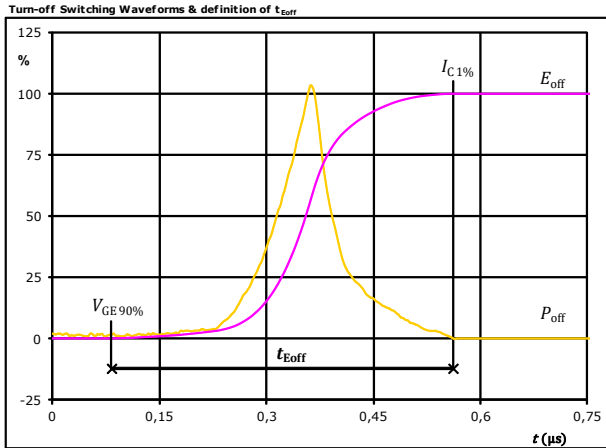


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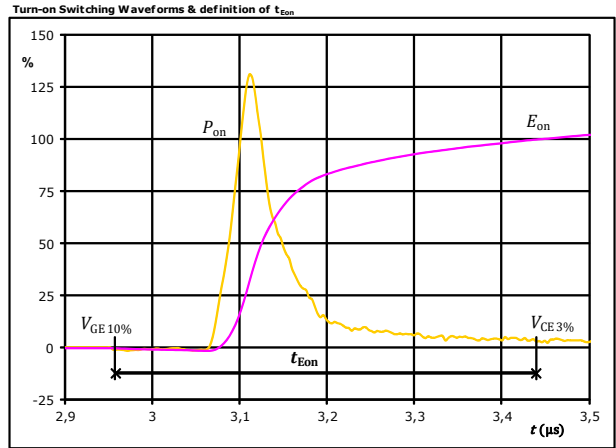
## Buck Switching Characteristics

**figure 5.** IGBT



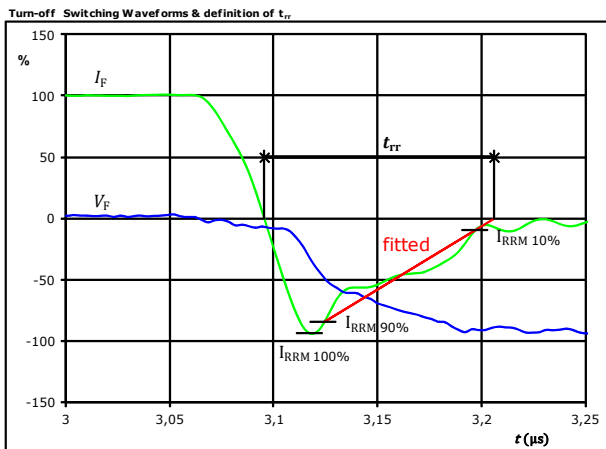
$P_{\text{off}}(100\%) = 90,12$  kW  
 $E_{\text{off}}(100\%) = 9,58$  mJ  
 $t_{\text{Eoff}} = 0,48$  μs

**figure 6.** IGBT



$P_{\text{on}}(100\%) = 90,12$  kW  
 $E_{\text{on}}(100\%) = 8,57$  mJ  
 $t_{\text{Eon}} = 0,48$  μs

**figure 7.** FWD



$V_F(100\%) = 600$  V  
 $I_F(100\%) = 150$  A  
 $I_{\text{RRM}}(100\%) = -139$  A  
 $t_{\text{rr}} = 0,111$  μs

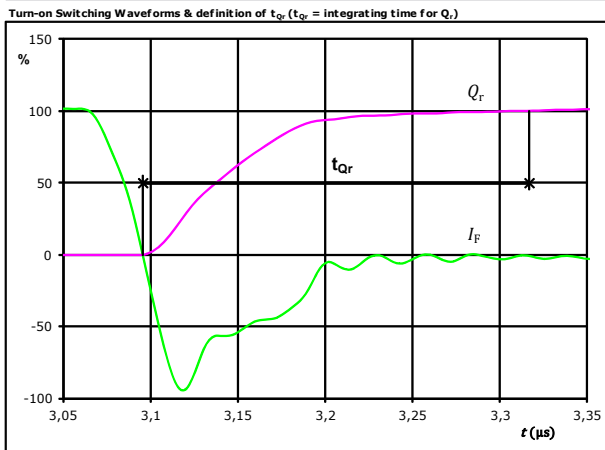


Vincotech

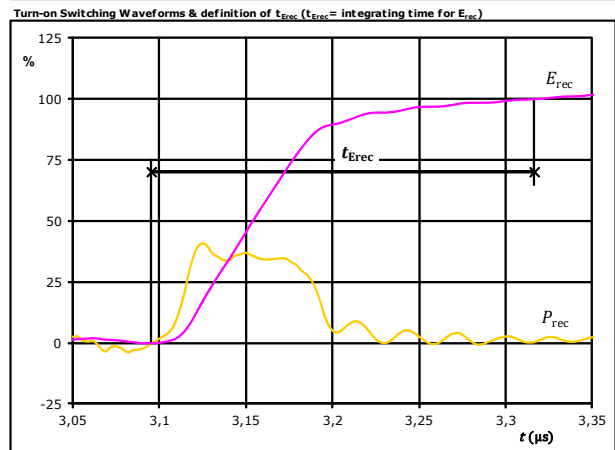
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Buck Switching Characteristics

**figure 8.** FWD



**figure 9.** FWD





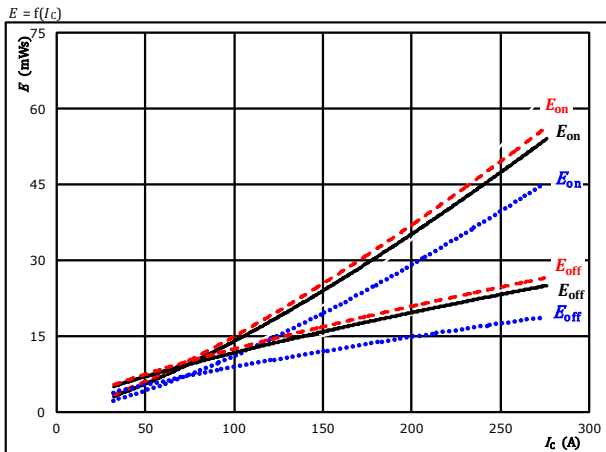
Vincotech

**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Boost Switching Characteristics

**figure 1.** IGBT

Typical switching energy losses as a function of collector current



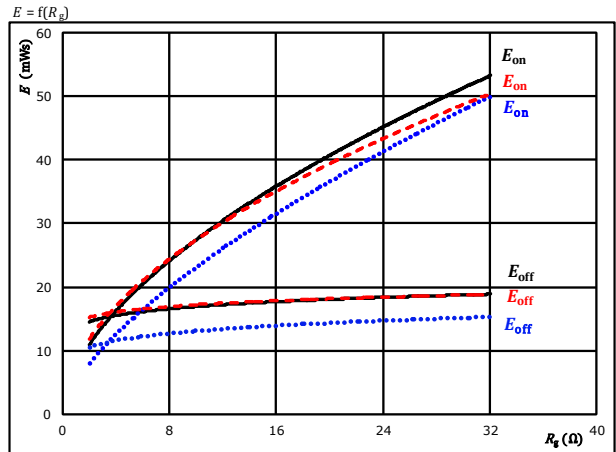
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$   $\Omega$   
 $R_{goff} = 8$   $\Omega$

$T_j$ : 25 °C (dotted blue)  
 125 °C (solid black)  
 150 °C (dashed red)

**figure 2.** IGBT

Typical switching energy losses as a function of gate resistor



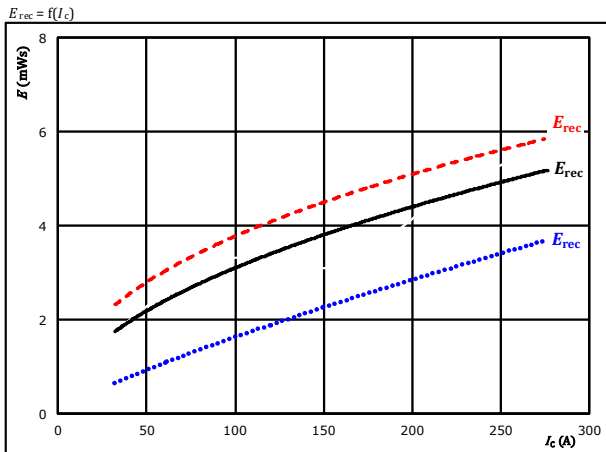
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 156$  A

$T_j$ : 25 °C (dotted blue)  
 125 °C (solid black)  
 150 °C (dashed red)

**figure 3.** FWD

Typical reverse recovered energy loss as a function of collector current



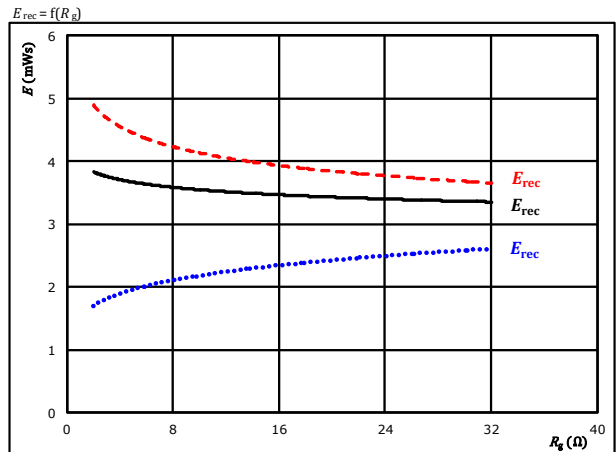
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$   $\Omega$

$T_j$ : 25 °C (dotted blue)  
 125 °C (solid black)  
 150 °C (dashed red)

**figure 4.** FWD

Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 156$  A

$T_j$ : 25 °C (dotted blue)  
 125 °C (solid black)  
 150 °C (dashed red)



Vincotech

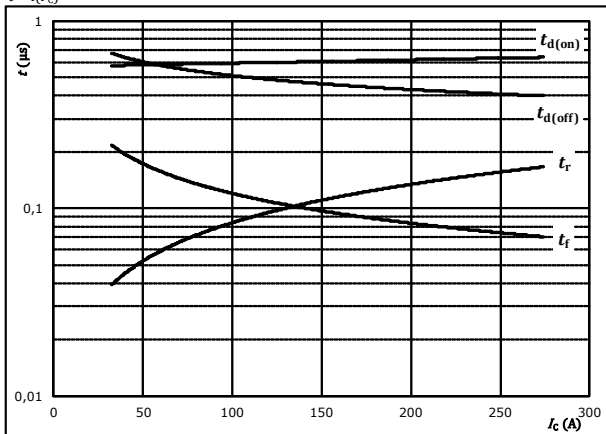
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

## Boost Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



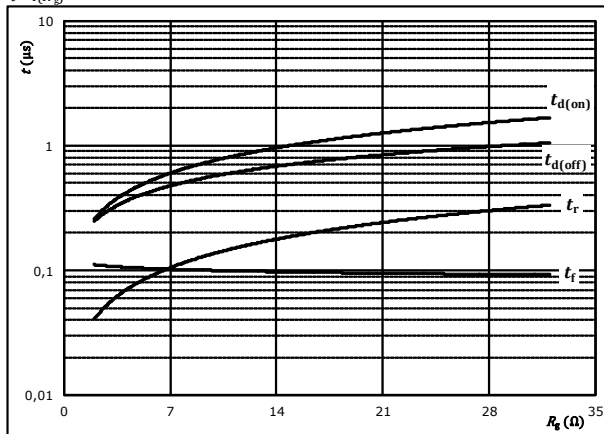
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω
$R_{goff} =$	8	Ω

**figure 6.** IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



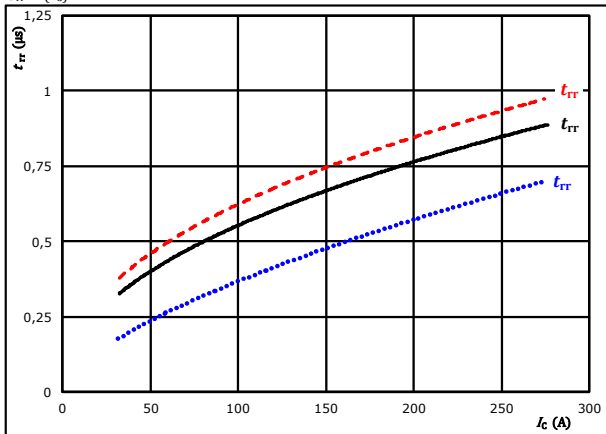
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	156	A

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

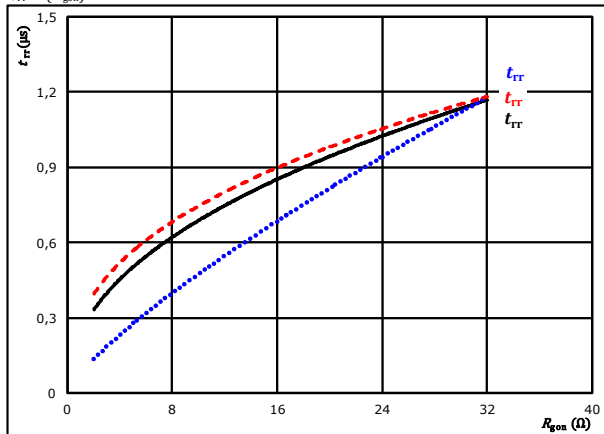


At	$V_{CE} =$	600	V	$T_j:$	25 °C	.....
	$V_{GE} =$	±15	V		125 °C	————
	$R_{gon} =$	8	Ω		150 °C	-----

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At	$V_{CE} =$	600	V	$T_j:$	25 °C	.....
	$V_{GE} =$	±15	V		125 °C	————
	$I_C =$	156	A		150 °C	-----



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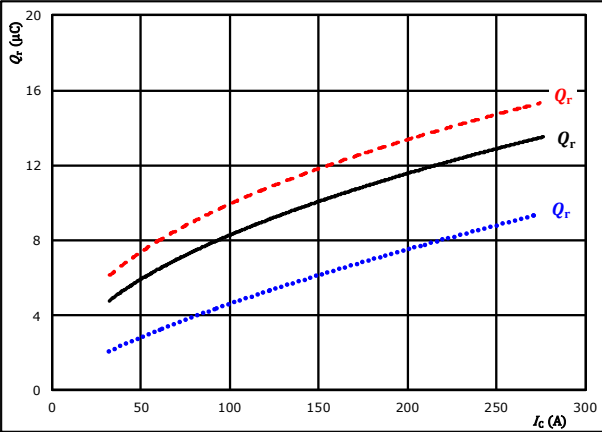
**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

## Boost Switching Characteristics

**figure 9.** FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_C)$$

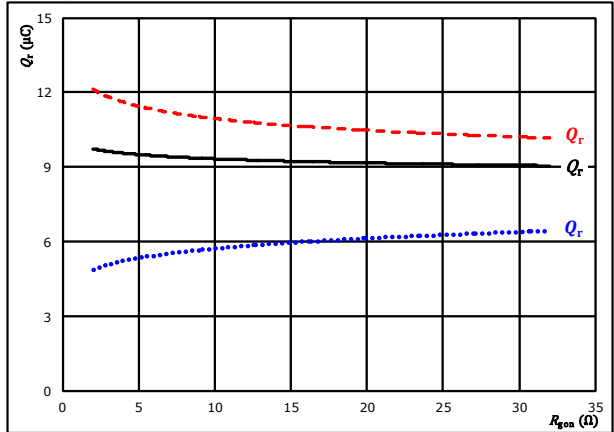


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω  
 $T_j: 25$  °C (dotted blue)  
 $125$  °C (solid black)  
 $150$  °C (dashed red)

**figure 10.** FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$

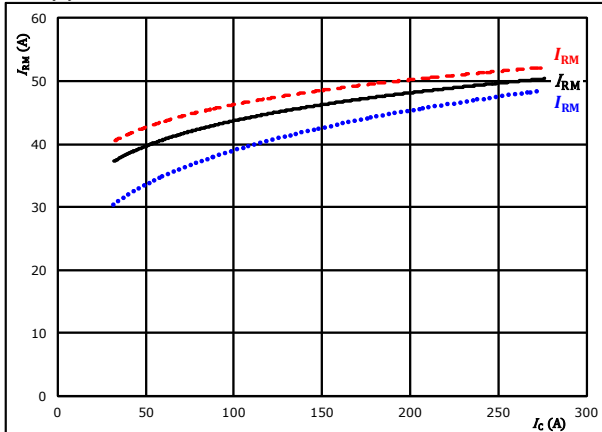


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 156$  A  
 $T_j: 25$  °C (dotted blue)  
 $125$  °C (solid black)  
 $150$  °C (dashed red)

**figure 11.** FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_C)$$

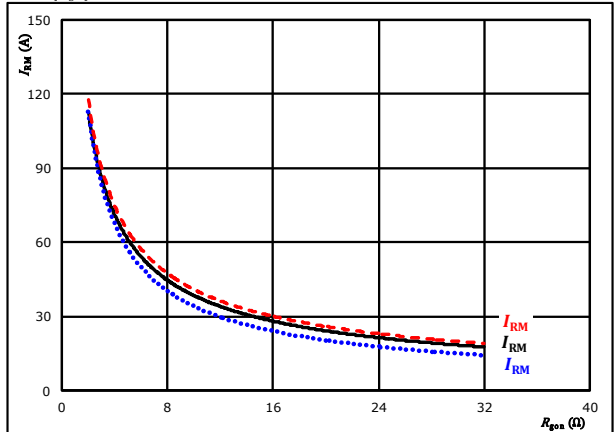


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω  
 $T_j: 25$  °C (dotted blue)  
 $125$  °C (solid black)  
 $150$  °C (dashed red)

**figure 12.** FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 156$  A  
 $T_j: 25$  °C (dotted blue)  
 $125$  °C (solid black)  
 $150$  °C (dashed red)



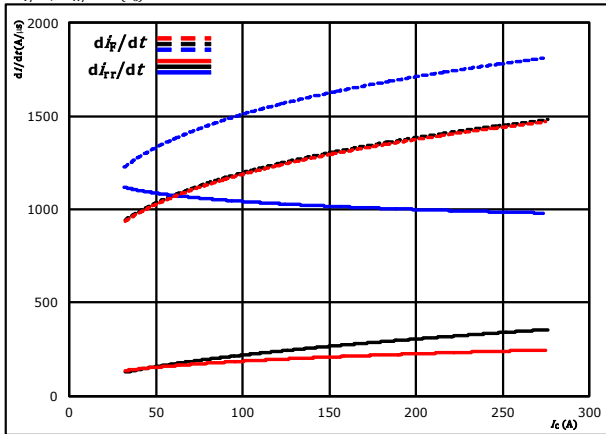
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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
 datasheet

## Boost Switching Characteristics

**figure 13.** FWD

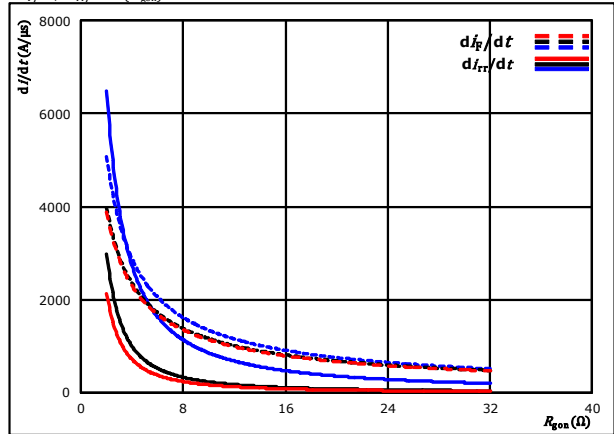
Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_F/dt, di_{rr}/dt = f(I_C)$



At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g0n} = 8$   $\Omega$   
 $T_J = 25$  °C (dotted blue)  
 $125$  °C (solid black)  
 $150$  °C (dashed red)

**figure 14.** FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor  
 $di_F/dt, di_{rr}/dt = f(R_{g0n})$

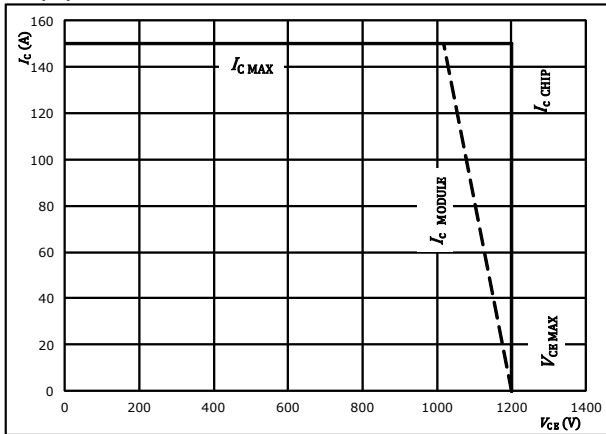


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 156$  A  
 $T_J = 25$  °C (dotted blue)  
 $125$  °C (solid black)  
 $150$  °C (dashed red)

**figure 15.** IGBT

Reverse bias safe operating area

$I_C = f(V_{CB})$



At  $T_J = 175$  °C  
 $R_{g0n} = 8$   $\Omega$   
 $R_{g0ff} = 8$   $\Omega$



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datasheet

## Boost Switching Characteristics

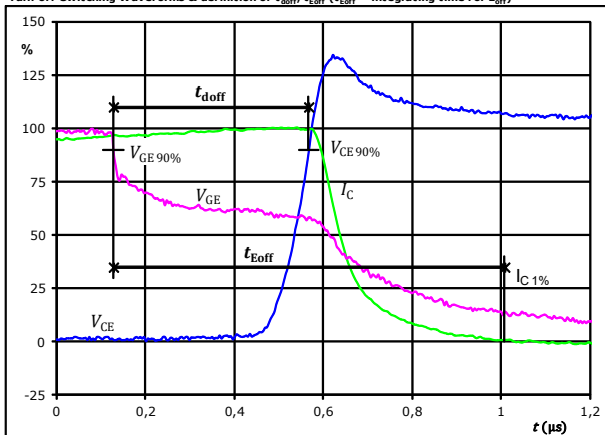
### General conditions

$T_j$	=	125 °C
$R_{gon}$	=	8 $\Omega$
$R_{goff}$	=	8 $\Omega$

figure 1.

IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

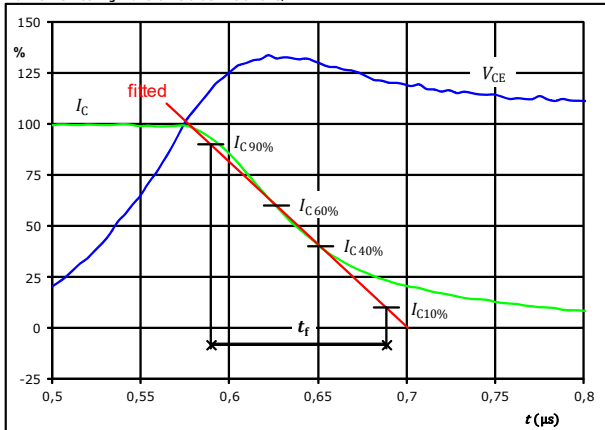


$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	156	A
$t_{doff} =$	0,440	$\mu s$
$t_{Eoff} =$	0,880	$\mu s$

figure 3.

IGBT

Turn-off Switching Waveforms & definition of  $t_f$

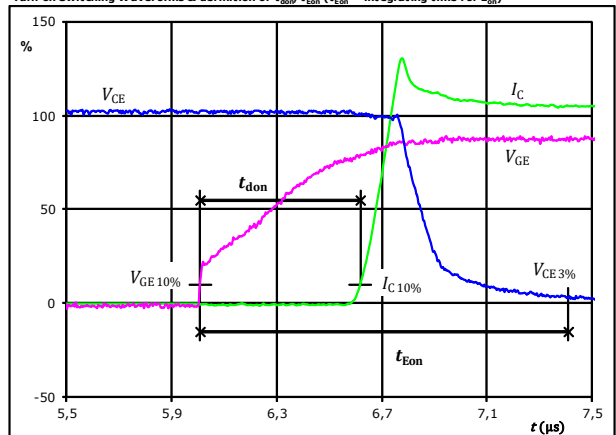


$V_C(100\%) =$	600	V
$I_C(100\%) =$	156	A
$t_f =$	0,101	$\mu s$

figure 2.

IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

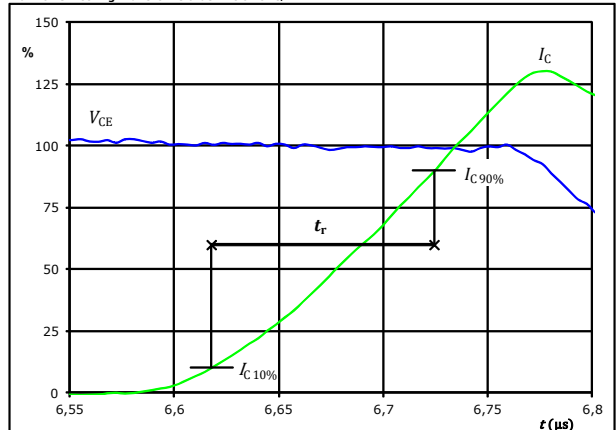


$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	156	A
$t_{don} =$	0,616	$\mu s$
$t_{Eon} =$	1,401	$\mu s$

figure 4.

IGBT

Turn-on Switching Waveforms & definition of  $t_r$



$V_C(100\%) =$	600	V
$I_C(100\%) =$	156	A
$t_r =$	0,106	$\mu s$

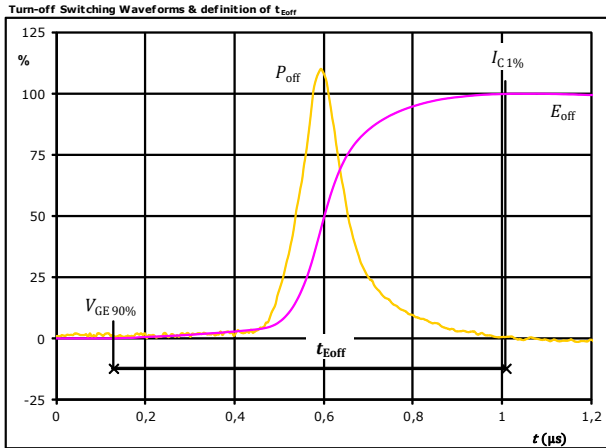


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# 10-F124NID150SH03-LG18F98 10-F124NIE150SH03-LG28F98 datasheet

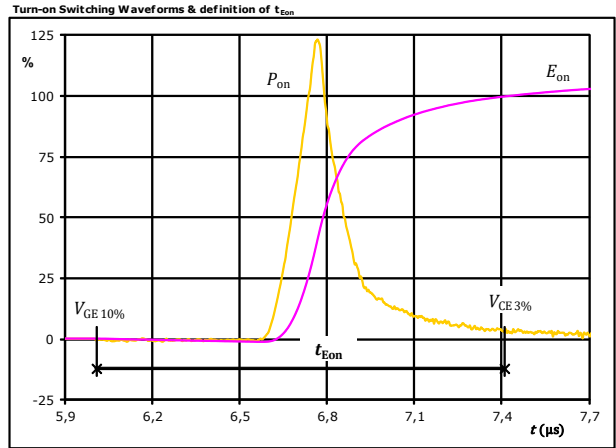
## Boost Switching Characteristics

figure 5. IGBT



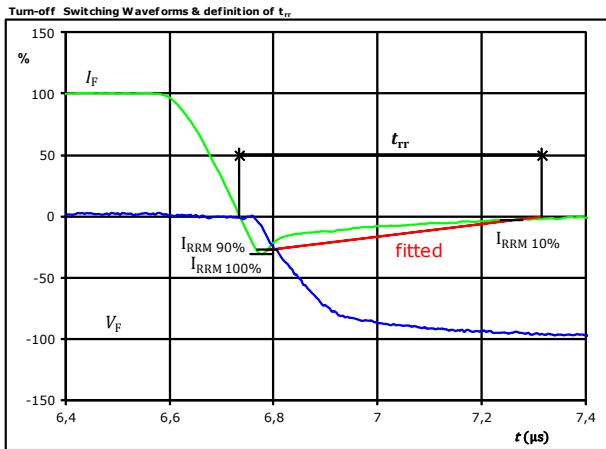
$P_{\text{off}}(100\%) = 93,69$  kW  
 $E_{\text{off}}(100\%) = 15,65$  mJ  
 $t_{\text{Eoff}} = 0,88$   $\mu\text{s}$

figure 6. IGBT



$P_{\text{on}}(100\%) = 93,69$  kW  
 $E_{\text{on}}(100\%) = 22,93$  mJ  
 $t_{\text{Eon}} = 1,40$   $\mu\text{s}$

figure 7. FWD



$V_F(100\%) = 600$  V  
 $I_F(100\%) = 156$  A  
 $I_{\text{RRM}}(100\%) = -48$  A  
 $t_{\text{rr}} = 0,590$   $\mu\text{s}$

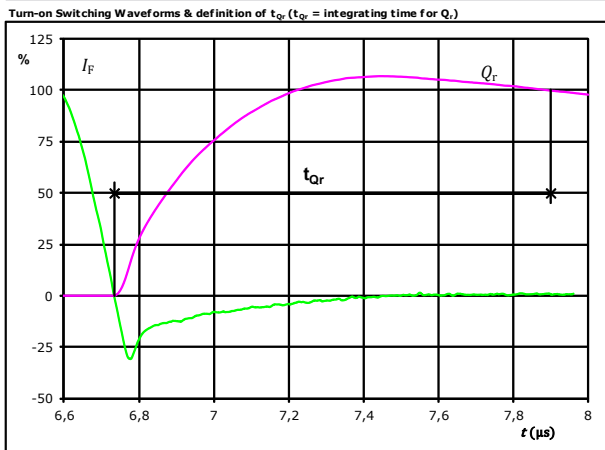


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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

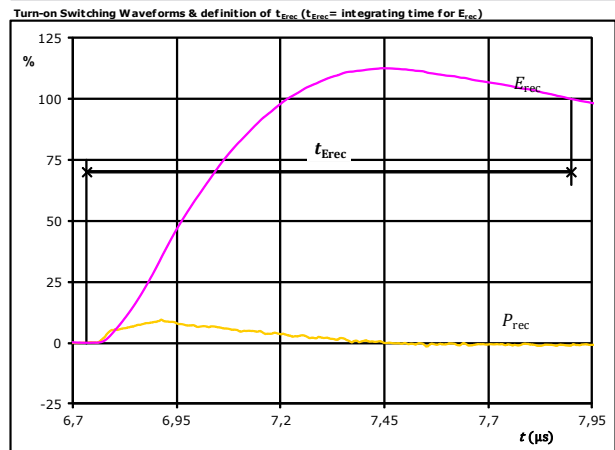
## Boost Switching Characteristics

figure 8. FWD



$I_F$ (100%) =	156	A
$Q_r$ (100%) =	8,80	$\mu$ C
$t_{Qr}$ =	1,17	$\mu$ s

figure 9. FWD

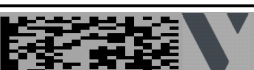


$P_{rec}$ (100%) =	93,69	kW
$E_{rec}$ (100%) =	3,15	mJ
$t_{Erec}$ =	1,17	$\mu$ s

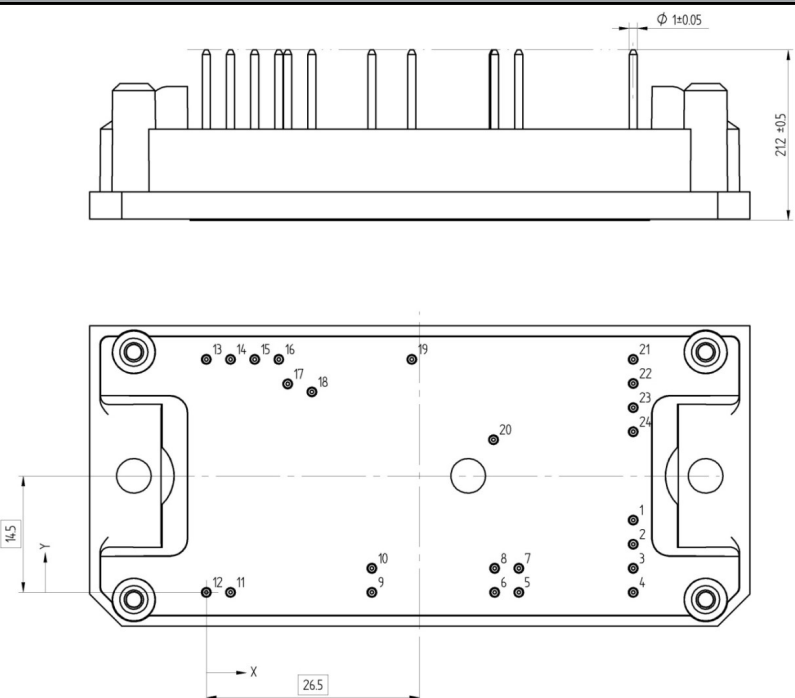


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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

Ordering Code & Marking									
Version			Ordering Code						
without thermal paste 17 mm housing with solder pins			10-F124NID150SH03-LG18F98						
with thermal paste 17 mm housing with solder pins			10-F124NID150SH03-LG18F98-/3/						
<div>NN-NNNNNNNNNNNNNN TTTTTVV WWYY UL VIN LLLLL SSSS</div> 			Text	Name		Date code	UL & VIN	Lot	Serial
				NN-NNNNNNNNNNNNNN-TTTTTTVV		WWYY	UL VIN	LLLLL	SSSS
			Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTTTTVV	LLLLL	SSSS	WWYY					

**High Side Module 10-F124NID150SH03-LG18F98**

Pin table [mm]				Outline	
Pin	X	Y	Function		
1	53	9	GND		
2	53	6	GND		
3	53	3	GND		
4	53	0	GND		
5	38,8	0	DC+		
6	35,8	0	DC+		
7	38,8	3	DC+		
8	35,8	3	DC+		
9	20,55	0	GI1		
10	20,55	3	S11		
11	3	0	Therm1		
12	0	0	Therm2		
13	0	29	Ph		
14	3	29	Ph		
15	6	29	Ph		
16	9	29	Ph		
17	10,1	25,95	S13		
18	13,1	24,95	GI3		
19	25,5	29	TM15		
20	35,65	19	TM11		
21	53	29	DC-		
22	53	26	DC-		
23	53	23	DC-		
24	53	20	DC-		

Tolerance of pinpositions: ±0.5mm at the end of pins  
Dimension of coordinate axis is only offset without tolerance

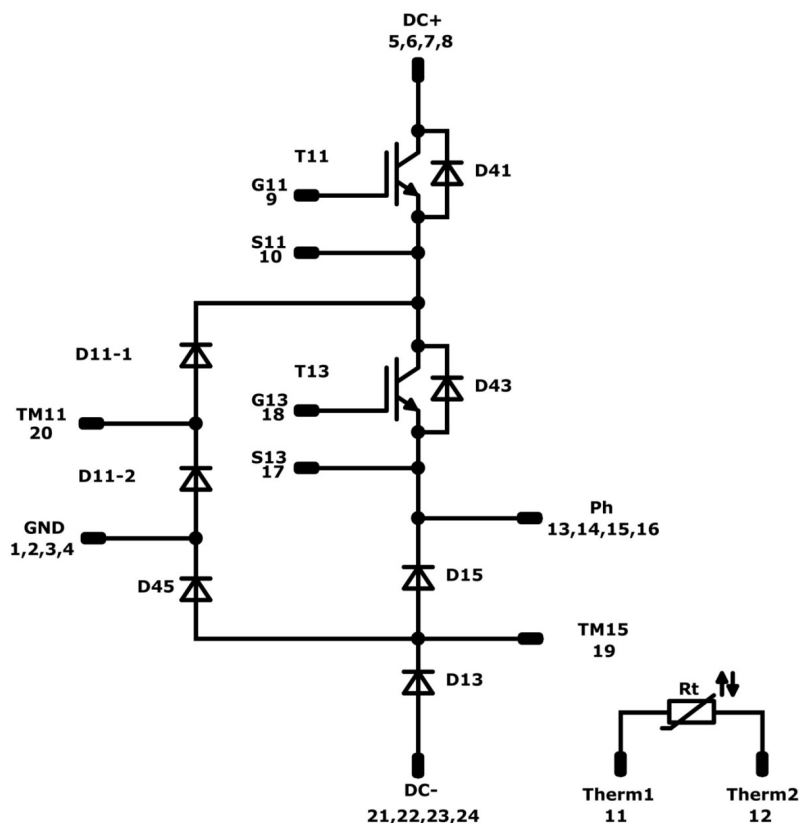


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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

**High Side Module 10-F124NID150SH03-LG18F98**

**Pinout**





**Identification**

ID	Component	Voltage	Current	Function	Comment
T11	IGBT	1200 V	150 A	Buck Switch	
D11-1, D11-2	FWD	1300 V	150 A	Buck Diode	Serial devices. Values apply to complete device.
D15	FWD	1200 V	50 A	Buck Sw. Protection Diode	
T13	IGBT	1200 V	150 A	Boost Switch	
D13	Rectifier	1600 V	50 A	Boost Diode	
D41	FWD	1200 V	50 A	Boost Sw. Inv. Diode	
D43	Rectifier	1600 V	50 A	Boost Sw. Protection Diode	
D45	FWD	1200 V	35 A	Boost D. Protection Diode	
Rt	NTC			Thermistor	



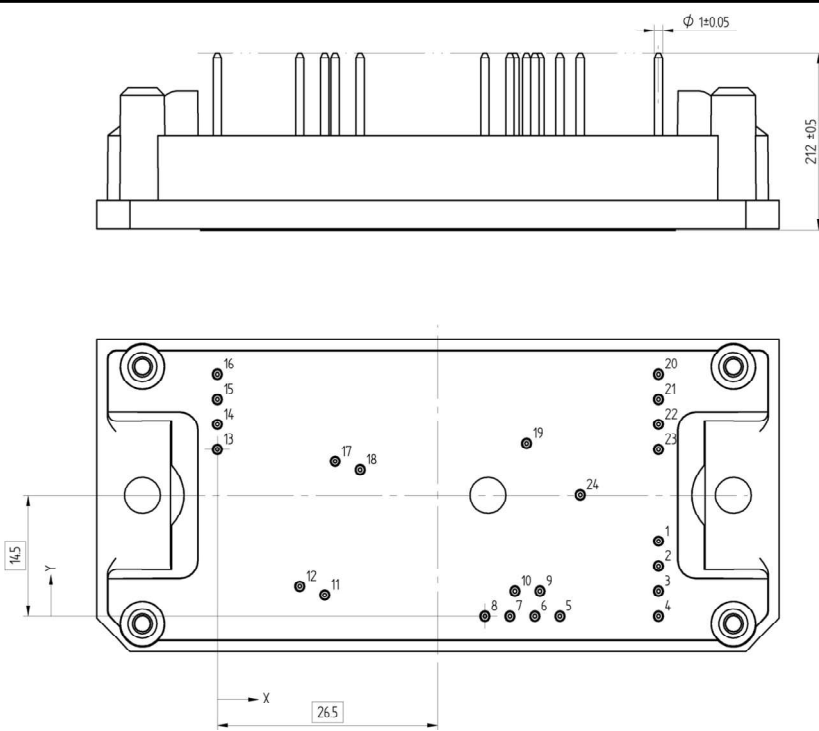
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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

Ordering Code & Marking										
Version				Ordering Code						
without thermal paste 17 mm housing with solder pins				10-F124NIE150SH03-LG28F98						
with thermal paste 17 mm housing with solder pins				10-F124NIE150SH03-LG28F98-/3/						
<div>NN-NNNNNNNNNNNNNN TTTTTVV WWYY UL VIN LLLLL SSSS</div>  				Text	Name		Date code	UL & VIN	Lot	Serial
					NN-NNNNNNNNNNNNNN-TTTTTVV		WWYY	UL VIN	LLLLL	SSSS
				Datamatrix	Type&Ver	Lot number	Serial	Date code		
					TTTTTTTTVV	LLLLL	SSSS	WWYY		

**Low Side Module 10-F124NIE150SH03-LG28F98**

Outline				
Pin table [mm]				
Pin	X	Y	Function	
1	53	9	GND	
2	53	6	GND	
3	53	3	GND	
4	53	0	GND	
5	41,15	0	DC-	
6	38,15	0	DC-	
7	35,15	0	DC-	
8	32,15	0	DC-	
9	38,75	3	Therm1	
10	35,75	3	Therm2	
11	12,9	2,55	S12	
12	9,9	3,55	G12	
13	0	20	Ph	
14	0	23	Ph	
15	0	26	Ph	
16	0	29	Ph	
17	14,15	18,55	G14	
18	17,15	17,55	S14	
19	37,15	20,7	TM12	
20	53	29	DC+	
21	53	26	DC+	
22	53	23	DC+	
23	53	20	DC+	
24	43,6	14,55	TM14	



Top view dimensions:  $\phi 1 \pm 0,05$ ,  $212 \pm 0,5$

Bottom view dimensions:  $14,5$ ,  $26,5$

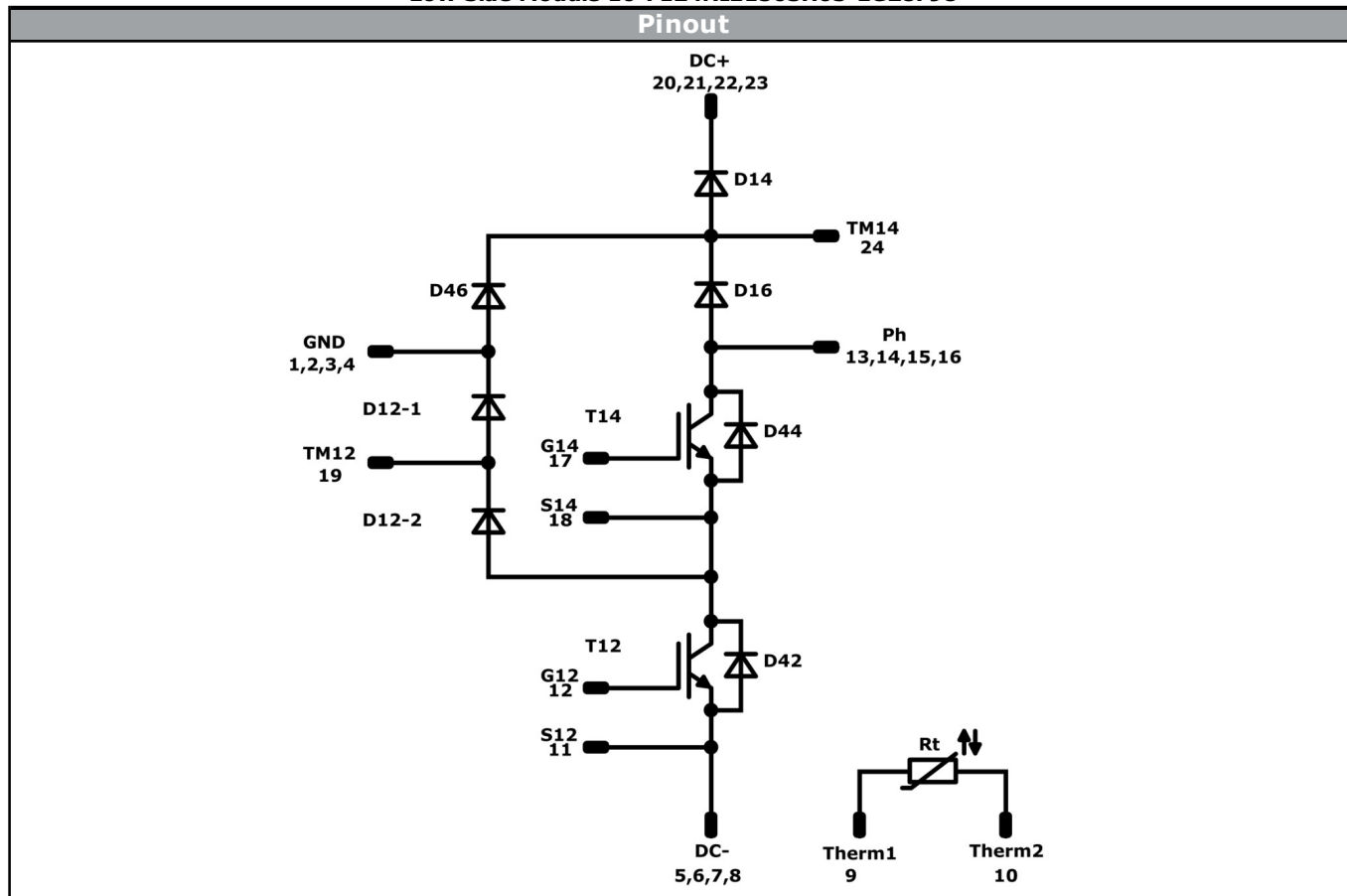
Tolerance of pinpositions:  $\pm 0,5$ mm at the end of pins  
Dimension of coordinate axis is only offset without tolerance



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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

Low Side Module 10-F124NIE150SH03-LG28F98



**Identification**

ID	Component	Voltage	Current	Function	Comment
T12	IGBT	1200 V	150 A	Buck Switch	
D12-1, D12-2	FWD	1300 V	150 A	Buck Diode	Serial devices. Values apply to complete device.
D16	FWD	1200 V	50 A	Buck Sw. Protection Diode	
T14	IGBT	1200 V	150 A	Boost Switch	
D14	Rectifier	1600 V	50 A	Boost Diode	
D42	FWD	1200 V	50 A	Boost Sw. Inv. Diode	
D44	Rectifier	1600 V	50 A	Boost Sw. Protection Diode	
D46	FWD	1200 V	35 A	Boost D. Protection Diode	
Rt	NTC			Thermistor	




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**10-F124NID150SH03-LG18F98**  
**10-F124NIE150SH03-LG28F98**  
datasheet

Packaging instruction			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-F124NIx150SH03-LGx8F98-D3-14	09 Jul. 2019	Marketing application voltage modified	1

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.